

Helixeon - White Series



Helixeon, a solid-state lighting device, provides high luminous flux output with high efficiency for the illumination applications. Helixeon is encapsulated in silicone by molding technology. It has characteristics of UV resistance and better heat loading. Also, Helixeon is capable of standard lead free solder reflow process.

Features

- I High luminous flux output
- I Silicone molding lens
- Standard lead free solder reflow process-JEDEC 020c
- I RoHS certification

Application

- I Torch lighting
- Down lighting
- Par lamp
- I General lighting
- I Brightness compensation



HELIO Optoelectronics Corp. Product Nomenclature

HM	HP	-	E	<u>1</u>	L	W
X 1	X2		X3	X4	X5	X6

X1		X2		X3		X4	
Item		Mode		Heat sink		Power	
Code	Туре	Code	Туре	Code	Туре	Code	Туре
HM	Molding	HP	High power	Е	Emitter	1	1W

X5		X6	
Pattern		Color	
Code	Туре	Code	Туре
L	Lambertian	W	White
		V	Warm white
		S	Neutral White

Circuit Diagram of HELIXEON- Emitter

Radiation Pattern	Part number	Circuit diagram
Lambertian	HMHP-E1LW	
Lambertian	HMHP-E1LV	
Lambertian	HMHP-E1LS	



Doc. No.: DS-01-09-02

Package Dimensions

Lead Form



Note:

- 1. The anode side of the device is denoted by a hole in the lead frame.
- 2. Electrical insulation between the case and the board is required. The slug of the device is no electrically neutral.
- 3. Drawings are not to scale.
- 4. All dimensions are all in millimeter.
- 5. All dimensions without tolerance are for reference only.
- 6. Specifications are subject to change without notice.



Characteristics for Helixeon white emitter

HMHP-E1LW

Characteristics at $I_F = 350 \text{mA} \text{ (Ta}=25^{\circ}\text{C} \text{)}$:

Domomotor	Symbol		Unit		
rarameter		Min	Typical	Max	
Luminous flux ⁽¹⁾	$\Phi_v^{(2)}$	77.3	85		lm
CRI	Ra		70		
View angle	2O _{1/2}		130		degree
Correlated color temperature ⁽³⁾	ССТ	5000		10000	К
Forward voltage ⁽⁴⁾	V _F	3.0		3.8	V
Power dissipation	PD	1.05		1.33	W
Junction temperature	TJ			120	Deg.
Operation temperature	T _{OP}		-40~+105		°C
Storage temperature	T _{ST}	-40~+120			°C
ESD sensitivity			>8000 HBM		V

Bin code

Luminous Flux (lm)	Rank (BIN)	Correlated color temperature (K)	Rank (BIN)
67.2	Т0	5000~5650	V
87.4	U0	5650~6300	W
113.6	V0	6300~7000	Х
147.7	WO	7000~8000	Y
		8000~10000	Z

Note:

- 1. The typical luminous flux of Helixeon will be upgraded per season.
- 2. Φ_v , minimum luminous flux performance guaranteed within published operating conditions. HELIO maintains a tolerance of ±10% luminous flux measurements.
- 3. The correlated color temperature of Helixeon is divided into three main bins. In case of customized CCT, this detail information will be discussed in meeting. The tester tolerance of CCT is $\pm 5\%$.
- 4. HELIO maintains a tolerance of ±0.06V on forward voltage measurements.



Characteristics for Helixeon white emitter

HMHP-E1LV

Characteristics at $I_F = 350 \text{mA} \text{ (Ta}=25^{\circ}\text{C} \text{)}$:

Domomotor	Symbol		Unit		
rarameter		Min	Typical	Max	
Luminous flux ⁽¹⁾	$\Phi_v^{(2)}$	59.5	70		lm
CRI	Ra		60		
View angle	2O _{1/2}		120		degree
Correlated color temperature ⁽³⁾	ССТ	2650		3250	К
Forward voltage ⁽⁴⁾	V _F	3.0		3.8	V
Power dissipation	P _D	1.05		1.33	W
Junction temperature	TJ			120	Deg.
Operation temperature	T _{OP}		-40~+105		°C
Storage temperature	T _{ST}	-40~+120			°C
ESD sensitivity			>8000 HBM		V

Bin code

Luminous Flux (lm)	Rank (BIN)	Correlated color temperature (K)	Rank (BIN)
51.7	S0	2650~2850	М
67.2	Т0	2850~3050	N
87.4	U0	3050~3250	Р
113.6	V0		

Note:

- 1. The typical luminous flux of Helixeon will be upgraded per season.
- 2. Φ_v , minimum luminous flux performance guaranteed within published operating conditions. HELIO maintains a tolerance of ±10% luminous flux measurements.
- 3. The correlated color temperature of Helixeon is divided into three main bins. In case of customized CCT, this detail information will be discussed in meeting. The tester tolerance of CCT is $\pm 5\%$.
- 4. HELIO maintains a tolerance of ±0.06V on forward voltage measurements.



Characteristics for Helixeon white emitter

HMHP-E1LS

Characteristics at $I_F = 350 \text{mA} \text{ (Ta}=25^{\circ}\text{C} \text{)}$:

Domomotor	Symbol		Unit		
rarameter		Min	Typical	Max	
Luminous flux ⁽¹⁾	$\Phi_v^{(2)}$	77.3	85		lm
CRI	Ra		70		
View angle	2O _{1/2}		120		degree
Correlated color temperature ⁽³⁾	ССТ	3500		4500	К
Forward voltage ⁽⁴⁾	V _F	3.0		3.8	V
Power dissipation	PD	1.05		1.33	W
Junction temperature	TJ			120	Deg.
Operation temperature	T _{OP}		-40~+105		°C
Storage temperature	T _{ST}	-40~+120			°C
ESD sensitivity			>8000 HBM		V

Bin code

Luminous Flux (lm)	Rank (BIN)	Correlated color temperature (K)	Rank (BIN)
51.7	S0	3500~3800	R
67.2	Т0	3800~4100	S
87.4	U0	4100~4500	Т
113.6	V0		

Note:

- 1. The typical luminous flux of Helixeon will be upgraded per season.
- 2. Φ_v , minimum luminous flux performance guaranteed within published operating conditions. HELIO maintains a tolerance of ±10% luminous flux measurements.
- 3. The correlated color temperature of Helixeon is divided into three main bins. In case of customized CCT, this detail information will be discussed in meeting. The tester tolerance of CCT is $\pm 5\%$.
- 4. HELIO maintains a tolerance of ±0.06V on forward voltage measurements.



750

800

HELIO Optoelectronics Corp.

Optical characteristics

Emission spectrum

HMHP-E1LW / HMHP-E1LV/ HMHP-E1LS

(White / Warm white / Neutral White)









Neutral white



Radiation Pattern





Warm white & Neutral white



Electrical characteristics

Typical Forward Current Characteristics



Typical Light Output Characteristics over Forward Current





Handling Precaution

The softness and dust affinity of silicone molding lens constrain the handling of LED. Thus, some handling indications of HELIXEON emitters are presented for possible damage prevention and excellent reliability.

- Avoid leaving fingerprints or scratches (by sharp tools) on the silicone resin parts.
- Do not force over 2000gf impact or pressure on the silicone molding lens.
- I The LEDs should only be picked up by making contact with the sides of the LED body.
- I When populating in SMT production, the pick-and-place nozzle must not place excessive pressure on the silicone molding lens.







Reliability Test List

Test Item	Standard	Test Conditions	Note	Number of
	Test Method			Damaged
Resistance to soldering heat (reflow soldering)	JEITA ED-4701 300 301	Ta=260°C, 10sec. (Pre treatment 25°C,70%,168hrs.)	2 times	0/10
Solderability (reflow soldering)	JEITA ED-4701 300 303	Tsld=215±5°C, 3sec. (Lead Solder)	1 time over 95%	0/10
Steady state operating life		$Ta{=}25^{\circ}C, \ I_F = 350mA$ Tested with Helio standard circuit board	1000 hrs.	0/10
Steady state operating life of high humidity heat		85° C, RH= 85° , I _F = $350mA$ Tested with Helio standard circuit board	1000 hrs.	0/10
Temperature cycle	JEITA ED-4701 100 105	-40°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min.	100 cycles	0/10
Thermal shock	JEITA ED-4701 300 307	0°C ~ 100°C 15sec. 15sec.	20 cycles	0/10
High temperature storage	JEITA ED-4701 200 201	Ta=100℃	1000 hrs.	0/10
Low temperature storage	JEITA ED-4701 200 202	Ta=-40℃	1000 hrs.	0/10
Vibration		2000 Hz, 2directions	60min.	0/10

Failure Criteria :

- I Forward Voltage shift $\therefore > 200 \text{ mV}$
- Luminous Flux degradation $\therefore > 10 \%$
- Forward or Reverse Leakage $:>10 \,\mu$ A
- I Catastrophic failure



Tube Package Specifications





Tube

Inner carton



Dry agent

Note:

- 1. There are 50pcs emitters in a tube.
- 2. An antistatic bag contains 20 tubes and a drying agent.
- 3. There are 20 tubes in an inner carton.
- 4. All dimensions are all in millimeter.